



SPECIFICATION

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10C471JB8NNNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 470pF, 50V, ±5%, C0G, 0603

A. Samsung Part Number

<u>CL</u> <u>10</u> <u>C</u> <u>471</u> <u>J</u> <u>B</u> <u>8</u> <u>N</u> <u>N</u> <u>N</u> <u>C</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor								
2	Size	0603 (inch c	code) L: 1.	.6	± 0.1	mm	W:	8.0	± 0.1	mm
3	Dielectric	C0G	(8	Inner el	ectrode		Ni		
4	Capacitance	470 pF			Termina	ation		Cu		
⑤	Capacitance	±5 %			Plating			Sn 10	0%	(Pb Free)
	tolerance		(9	Product	t		Norm	al	
6	Rated Voltage	50 V	(10	Special			Reser	ved for	future use
7	Thickness	0.8 ± 0.1	mm (11)	Packagi	ing		Cardb	oard T	ype, 7" reel

B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition					
Capacitance	Within specified tolerance	1Mb±10% 0.5~5Vrms					
Q	1000 min						
Insulation	10,000Mohm or 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Microscope (×10)					
Withstanding	No dielectric breakdown or	300% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	COG						
Characterisitcs	(From -55 $^{\circ}$ C to 125 $^{\circ}$ C, Capacitance change shoud be within ±30PPM/ $^{\circ}$ C)						
Adhesive Strength	No peeling shall be occur on the	500g⋅F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change :	Bending to the limit (1mm)					
	within ±5% or ±0.5pF whichever is larger	with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120℃ for 10~30sec.)					
Resistance to	Capacitance change :	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	within ±2.5% or ±0.25pF whichever is larger						
	Tan δ, IR : initial spec.						

	Performance	Test condition					
Vibration Test	Capacitance change :	Amplitude : 1.5mm					
	within ±2.5% or ±0.25pF whichever is larger	From 10Hz to 55Hz (return : 1min.)					
	Tan δ, IR : initial spec.	2hours \times 3 direction (x, y, z)					
Moisture	Capacitance change :	With rated voltage					
Resistance	within ±7.5% or ±0.75pF whichever is larger	40±2℃, 90~95%RH, 500+12/-0hrs					
	Q: 200 min						
	IR : 500Mohm or 25Mohm $\cdot \mu$ F						
	Whichever is Smaller						
High Temperature	Capacitance change :	With 200% of the rated voltage					
Resistance	within ±3% or ±0.3pF whichever is larger	Max. operating temperature					
	Q: 350 min	1000+48/-0hrs					
	IR : 1000Mohm or 50Mohm $\cdot \mu$ F						
	Whichever is Smaller						
Temperature	Capacitance change :	1 cycle condition					
Cycling	within ±2.5% or ±0.25pF whichever is larger	Min. operating temperatur → 25 ℃					
	Tan δ, IR : initial spec.	$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!\!$					
		5 cycle test					

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C, 10sec. Max)

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.



Multi Layer Ceramic Capacitor (MLCC)



1. Model: CL10C471JB8NNNC

2. Description

Part no.	CL10C471JB8NNNC		
Size (inch / mm)	0603/1608		
Thickness (mm)	0.8		
Temperature charateristics	C0G		
Capacitance	470 pF		
Capacitance tolerance (%)	± 5 %		
Voltage (V)	50		

3. Frequency characteristics

Network Analyzer, 0.5Vrms, 1MHz to 20GHz

